



BT15T120 CNR

General Description:

Using HUAJING's proprietary trench design, advanced FS(field stop) technology and integrated with Free Wheeling Diode, the 1200V Trench FS IGBT offers superior conduction and switching performances, high avalanche ruggedness.

Features:

- l Trench FS Technology, Positive temperature coefficient
- l Low saturation voltage: $V_{CE(sat)}$, typ =1.95V @ $I_C=15A$
- l Extremely enhanced avalanche capability

Applications:

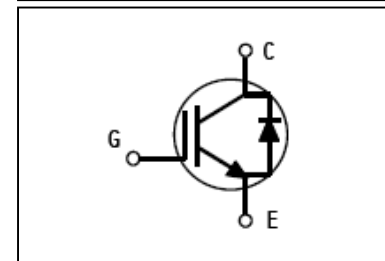
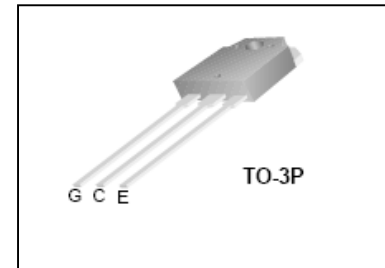
Power switch circuit of induction cooker(IH).

Absolute Maximum Ratings

($T_J=25^{\circ}C$ unless otherwise specified):

Symbol	Parameter	Rating	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate- Emitter Voltage	± 20	V
I_C	Collector Current@ $T_C = 25^{\circ}C$	30	A
	Collector Current @ $T_C = 100^{\circ}C$	15	A
I_{CM}^{al}	Pulsed Collector Current@ $T_C = 25^{\circ}C$	45	A
I_F	Diode Continuous Forward Current @ $T_C = 100^{\circ}C$	15	A
I_{FM}	Diode Maximum Forward Current@ $T_C = 25^{\circ}C$	45	A
P_D	Power Dissipation @ $T_C = 25^{\circ}C$	156	W
	Power Dissipation @ $T_C = 100^{\circ}C$	62	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	150, -55 to +150	$^{\circ}C$
T_L	Maximum Temperature for Soldering	270	$^{\circ}C$

V_{CES}	1200	V
I_C	15	A
$P_{tot}(T_C=25^{\circ}C)$	156	W
$V_{CE(SAT)}$	1.95	V



Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction to case for IGBT	0.55	0.8	$^{\circ}C/W$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	35	40	$^{\circ}C/W$

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_{CE}=1mA$	1200	--	--	V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0V, V_{CE}=V_{CES}$	--	--	1.0	mA
$I_{GES(F)}$	Gate to Emitter Forward Leakage	$V_{GE}=+20V$	--	--	+250	nA
$I_{GES(R)}$	Gate to Source Reverse Leakage	$V_{GE}=-20V$	--	--	-250	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=15A, V_{GE}=15V$	--	1.95	2.5	V
V_{FM}	Diode Forward Voltage	$I_F=15A$	--	2.7	3.2	V
$V_{GE(TH)}$	Gate Threshold Voltage	$I_C=250\mu A, V_{CE}=V_{GE}$	4.5	5.8	7.5	V
Pulse width $tp \leq 300\mu s, \delta \leq 2\%$						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V$ $f=1MHz$	--	1513	--	pF
C_{oes}	Output Capacitance		--	35	--	
C_{res}	Reverse Transfer Capacitance		--	25	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$T_j = 25^\circ\text{C}$ $V_{CE}=600V, I_C=15A$ $V_{GE}=0/15V,$ $R_g=10\Omega$ Inductive Load	--	14	--	ns
t_r	Rise Time		--	32	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	107	--	
t_f	Fall Time		--	131	--	mJ
Eon	Turn-On Switching Loss		--	0.43	--	
Eoff	Turn-Off Switching Loss		--	0.7	--	
Ets	Total Switching Loss		--	1.13	--	
Q_g	Total Gate Charge	$V_{CE}=960V, I_C=15A$ $V_{GE}=15V$	--	81.5	--	nC
Q_{ge}	Gate to Emitter Charge		--	7.5	--	
Q_{gc}	Gate to Collector Charge		--	51.5	--	

Characteristics Cure

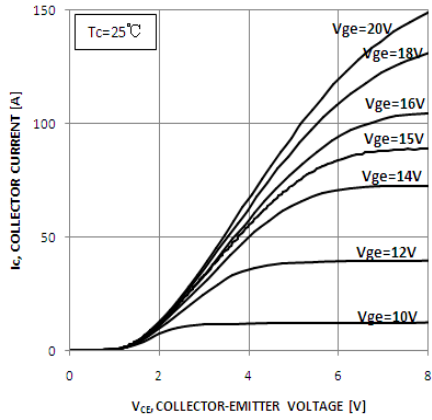


Figure 1. Typical Output Characteristics

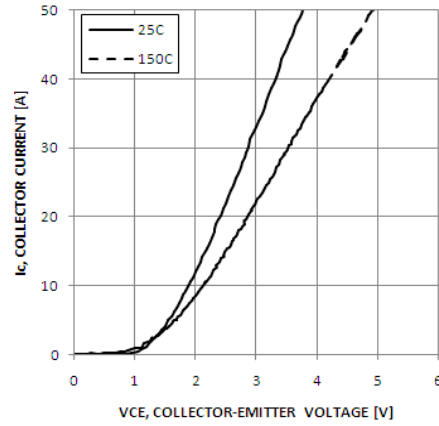


Figure 2. Typical Output Characteristics

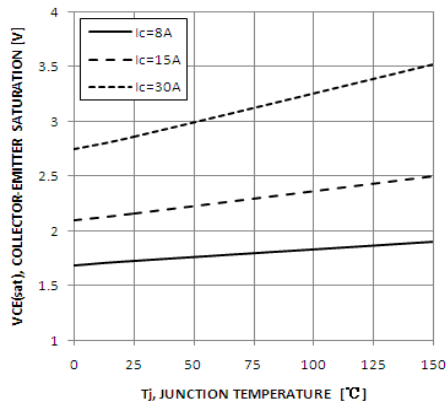


Figure 3. Typical Saturation Voltage vs. Junction Temperature

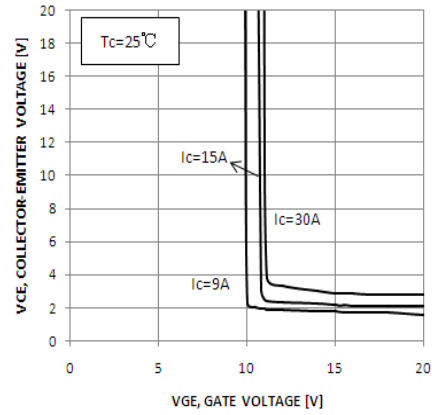


Figure 4. Typical Saturation Voltage vs. Gate-Emitter Voltage

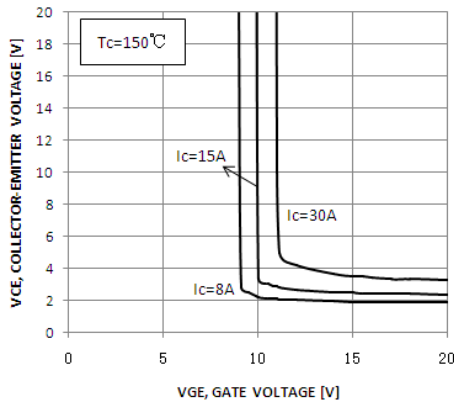


Figure 5. Typical Saturation Voltage vs. Gate-Emitter Voltage

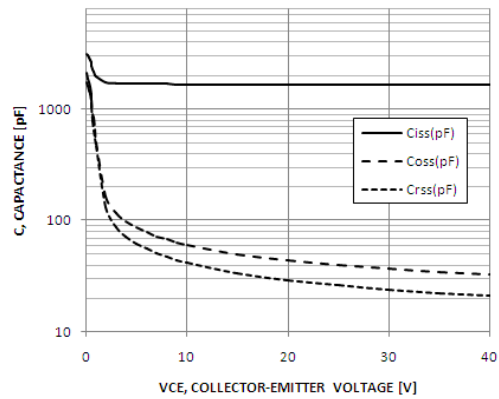


Figure 6. Typical Capacitance Characteristics

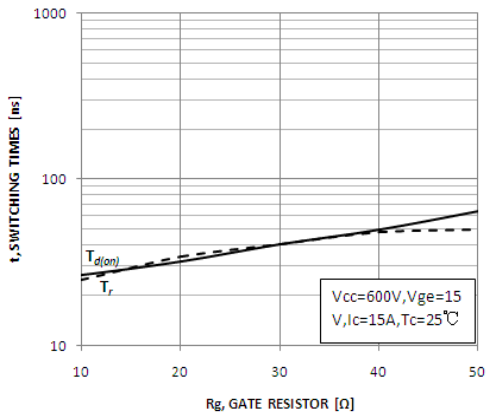


Figure 7. Typical Turn-On Characteristics vs. Gate Resistance

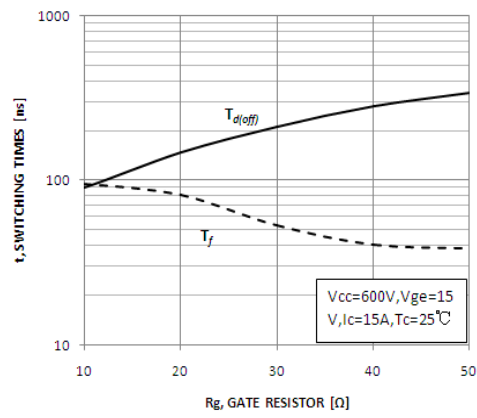


Figure 8. Typical Turn-Off Characteristics vs. Gate

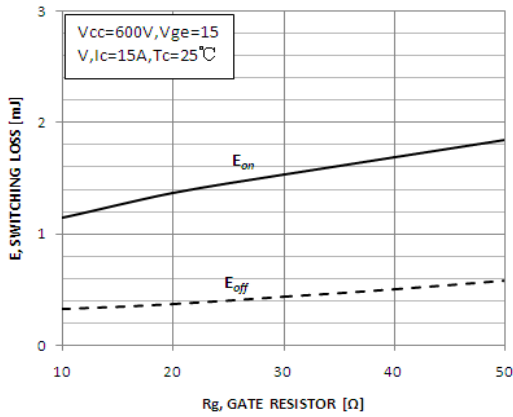


Figure 9. Typical Switching Losses vs. Gate Resistance

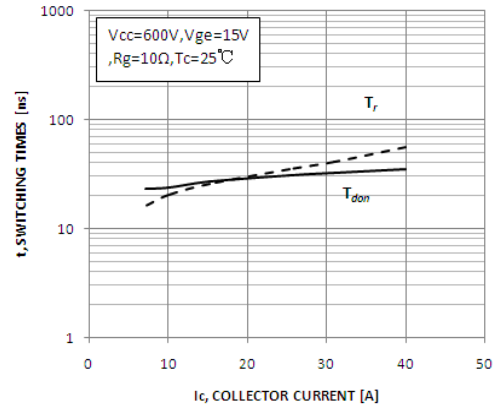


Figure 10. Typical Turn-On Characteristics vs. Collector Current

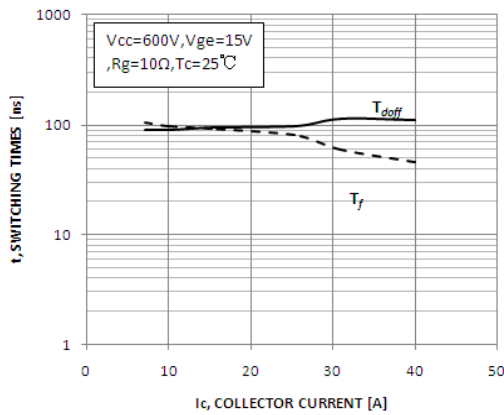


Figure 11. Typical Turn-Off Characteristics vs. Collector Current

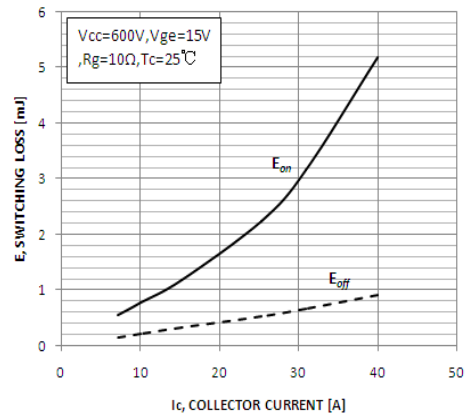


Figure 12. Typical Switching Losses vs. Collector Current

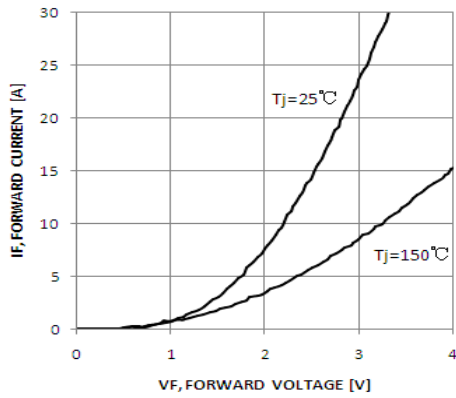


Figure 13. Typical Diode Forward Characteristics

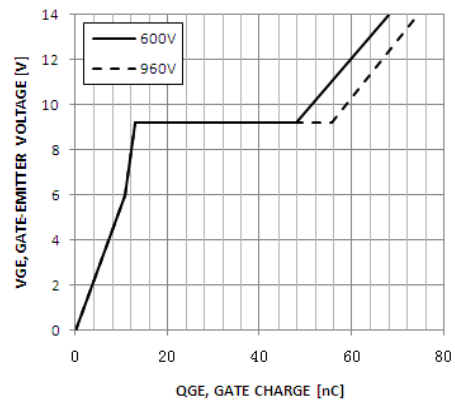


Figure 14. Typical Gate Charge

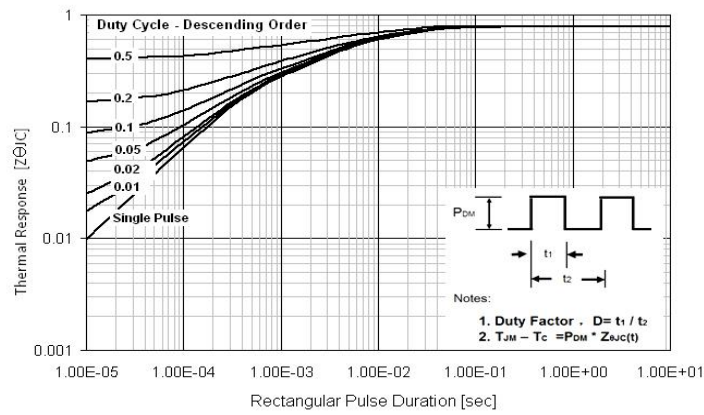
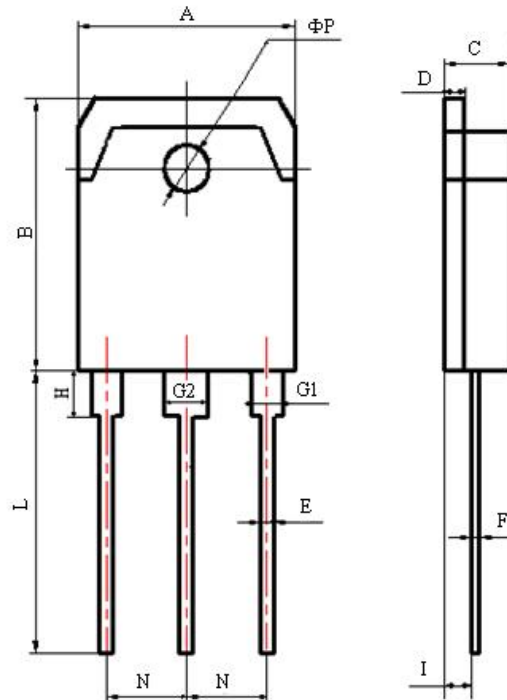


Figure 15. Transient Thermal Impedance of IGBT

Package Information


Items	Values(mm)	
	MIN	MAX
A	15.00	16.00
B	19.20	20.60
C	4.60	5.00
D	1.40	1.60
E	0.90	1.10
F	0.50	0.70
G1	2.00	2.20
G2	3.00	3.20
H	3.00	3.70
I	1.20	1.70
	2.70	2.90
L*	19.00	21.00
N	5.25	5.65
Φ P	3.10	3.30

*: adjustable

TO-3P(N) Package

The name and content of poisonous and harmful material in products

Part's Name	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DIBP	DEHP	DBP	BBP
Limit	≤ 0.1%	≤ 0.1%	≤ 0.01%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	○: Means the hazardous material is under the criterion of 2011/65/EU. ×: Means the hazardous material exceeds the criterion of 2011/65/EU. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.									

Warnings

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. IGBTs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

WUXI CHINA RESOURCES HUAJING MICROELECTRONICS CO., LTD.

Add: No.14 Liangxi RD. Wuxi, Jiangsu, China **Mail:** 214061 <http://www.crhj.com.cn>
Tel: 0510-85807228 **Fax:** 0510-85800864

Marketing Part: **Post:** 214061 **Tel / Fax:** 0510-85807228-3663/5508
0510-85800360 (Fax)

Application and Service: **Post:** 214061 **Tel / Fax:** 0510-85807228-3399 / 2227

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [IGBT Transistors](#) category:

Click to view products by [Huajing](#) manufacturer:

Other Similar products are found below :

[748152A](#) [FGH60T65SHD_F155](#) [APT100GT60B2RG](#) [APT13GP120BG](#) [APT20GN60BG](#) [APT20GT60BRDQ1G](#) [APT25GN120B2DQ2G](#)
[APT35GA90BD15](#) [APT36GA60BD15](#) [APT40GP60B2DQ2G](#) [APT40GP90B2DQ2G](#) [APT50GN120B2G](#) [APT50GT60BRG](#)
[APT64GA90B2D30](#) [APT70GR120J](#) [NGTB10N60FG](#) [NGTB30N60L2WG](#) [NGTG25N120FL2WG](#) [IGP30N60H3XKSA1](#) [STGB15H60DF](#)
[STGFW20V60DF](#) [STGFW30V60DF](#) [STGFW40V60F](#) [STGWA25H120DF2](#) [FGB3236_F085](#) [APT25GN120BG](#) [APT25GR120S](#)
[APT30GN60BDQ2G](#) [APT30GN60BG](#) [APT30GP60BG](#) [APT30GS60BRDQ2G](#) [APT30N60BC6](#) [APT35GP120JDQ2](#) [APT36GA60B](#)
[APT45GR65B2DU30](#) [APT50GP60B2DQ2G](#) [APT68GA60B](#) [APT70GR65B](#) [APT70GR65B2SCD30](#) [GT50JR22\(STA1ES\)](#) [TIG058E8-TL-H](#)
[IDW40E65D2](#) [SGB15N120ATMA1](#) [NGTB50N60L2WG](#) [STGB10H60DF](#) [STGB20V60F](#) [STGB40V60F](#) [STGFW80V60F](#)
[IGW40N120H3FKSA1](#) [RJH60D7BDPQ-E0#T2](#)